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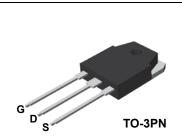
FQA13N80-F109 N-Channel QFET[®] MOSFET 800 V, 12.6 A, 750 mΩ

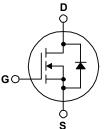
Description

This N-Channel enhancement mode power MOSFET is produced using ON Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- + 12.6 A, 800 V, $\rm R_{DS(on)}$ = 750 m Ω (Max.) @ V_{GS} = 10 V, $\rm I_{D}$ = 6.3 A
- Low Gate Charge (Typ. 68 nC)
- Low Crss (Typ. 30 pF)
- 100% Avalanche Tested





Absolute Maximum Ratings T_c = 25°C unless otherwise noted.

Symbol	Parameter		FQA13N80-F109	Unit	
V _{DSS}	Drain-Source Voltage		800	V	
I _D	Drain Current - Continuous ($T_C = 25^{\circ}C$)		12.6	А	
	- Continuous (T _C = 100°C)		8.0	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	50.4	А	
V _{GSS}	Gate-Source Voltage	±30	V		
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	1100	mJ	
I _{AR}	Avalanche Current	(Note 1)	12.6	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	30	mJ	
dv/dt	Peak Diode Recovery dv/dt (No		4.0	V/ns	
P _D	Power Dissipation (T _C = 25°C)		300	W	
	- Derate above 25°C		2.38	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +150	°C		
Τ _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

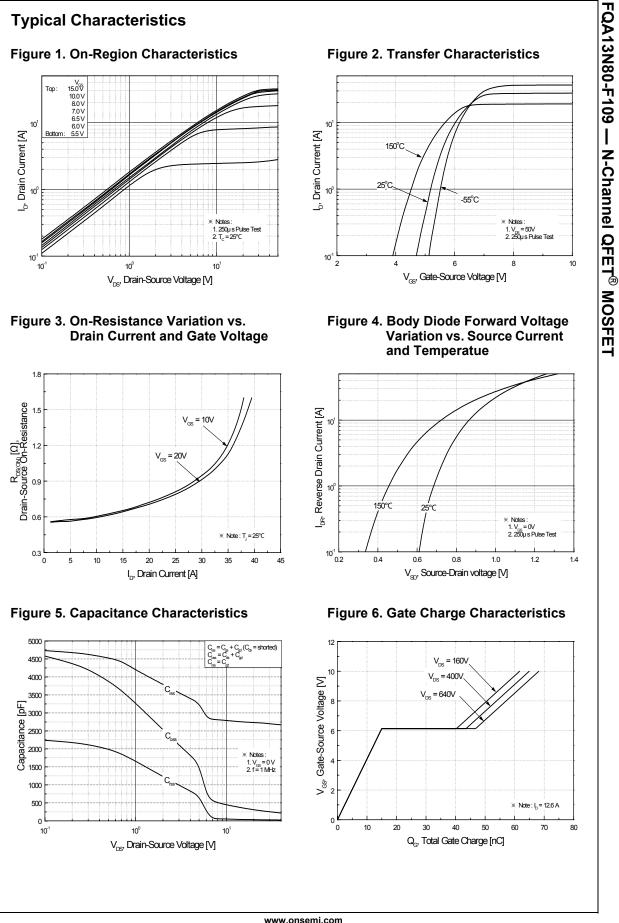
Symbol	Parameter	FQA13N80_F109	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	0.42	°C/W	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink, Typ.	0.24	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	40	°C/W	

Publication Order Number: FQA13N80-F109/D

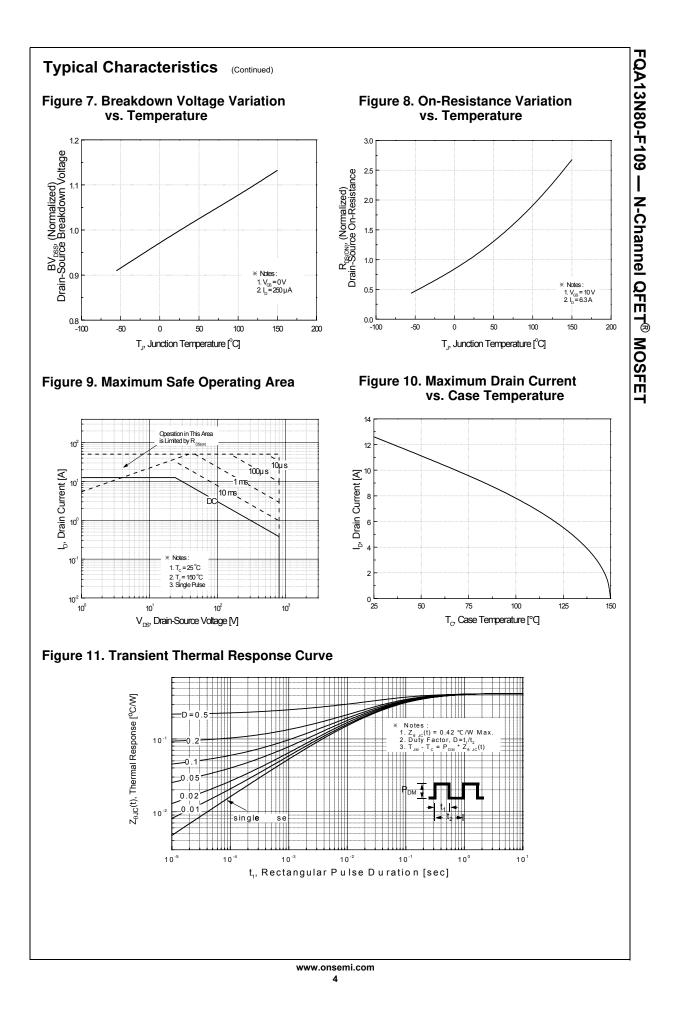
Part Number		Top Mark	Package	Packing Method	Reel Size	Tape Wi	dth Q	Quantity	
FQA13N80	QA13N80-F109 FQA13N80 TO-3PN		Tube	N/A	N/A	3	30 units		
Electric	al Cha	aracteristics	$T_c = 25^{\circ}C$ unless othe	rwise noted.					
Symbol		Paramete	r	Test Condition	s Min	Тур	Max	Unit	
Off Charac	teristics								
BV _{DSS}	Drain-Source Breakdown Voltage		V _{GS} = 0 V, I _D = 250 μA 800				V		
ΔΒV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient		$I_D = 250 \ \mu$ A, Referenced to 25°C		0.95		V/°C		
I _{DSS}	Zero Ga	ate Voltage Drain Current		V_{DS} = 800 V, V_{GS} = 0	V		10	μA	
			V _{DS} = 640 V, T _C = 125	5°C		100	μA		
I _{GSSF}	Gate-B	ody Leakage Current	, Forward	V_{GS} = 30 V, V_{DS} = 0 V			100	nA	
I _{GSSR}	Gate-B	ody Leakage Current	, Reverse	V_{GS} = -30 V, V_{DS} = 0 V	V		-100	nA	
On Charact	eristics			-			-		
V _{GS(th)}	Gate Th	nreshold Voltage		V_{DS} = V_{GS} , I_D = 250 μ	A 3.0		5.0	V	
R _{DS(on)}	Static D	rain-Source On-Res	stance	V_{GS} = 10 V, I _D = 6.3A		0.58	0.75	Ω	
9 _{FS}	Forward	Forward Transconductance		V_{DS} = 50 V, I _D = 6.3A		13		S	
Dynamic Ch	naracteris	stics		1		1	T	1	
C _{iss}	Input C	apacitance		$V_{DS} = 25 V, V_{GS} = 0 V,$	',	2700	3500	pF	
C _{oss}	Output	Capacitance		f = 1.0 MHz		275	360	pF	
C _{rss}		e Transfer Capacitan	се			30	39	pF	
Switching C				Γ			1	1	
t _{d(on)}	Turn-O	n Delay Time		$V_{DD} = 400 \text{ V}, \text{ I}_{D} = 12.6\text{ A},$ R _G = 25 Ω	6A,	60	130	ns	
t _r	Turn-O	n Rise Time		NG 2032		150	310	ns	
t _{d(off)}	Turn-Of	f Delay Time		(Niet		155	320	ns	
t _f	Turn-Of	f Fall Time		(Not		110	230	ns	
Qg	Total Ga	ate Charge		V _{DS} = 640 V, I _D = 12.6	6A,	68	88	nC	
Q _{gs}	Gate-Se	ource Charge		V _{GS} = 10 V		15		nC	
Q _{gd}	Gate-D	rain Charge		(Not	e 4)	32		nC	
•	e Diode	Characteristics and	Maximum Rating	S	l			1	
I _S	Maximum Continuous Drain-Source Diode Forwa						12.6	Α	
I _{SM}	Maximum Pulsed Drain-Source Diode Forwa		rd Current			50.4	Α		
V _{SD}	Drain-S	ource Diode Forward	d Voltage	V _{GS} = 0 V, I _S = 12.6A			1.4	V	
t _{rr}	Reverse	e Recovery Time		V _{GS} = 0 V, I _S = 12.6 A,		850		ns	
Q _{rr}	Reverse	e Recovery Charge		dI _F / dt = 100 A/µs		11.3		μC	

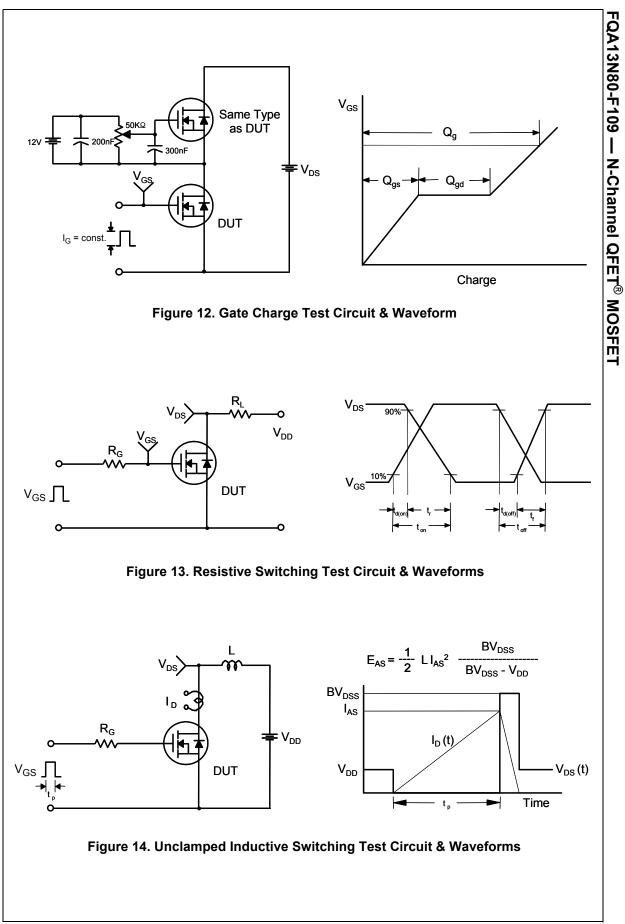
FQA13N80-F109 — N-Channel QFET[®] MOSFET

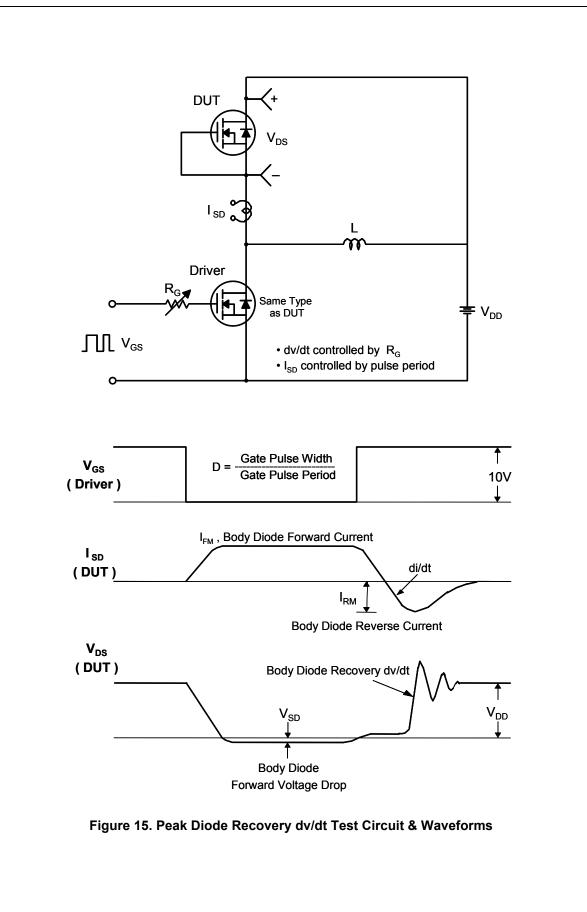
Notes: 1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 13 mH, I_{AS} = 12.6 A, V_{DD} = 50 V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} ≤ 12.6 A, di/dt ≤ 200 A/µs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C 4. Essentially independent of operating temperature

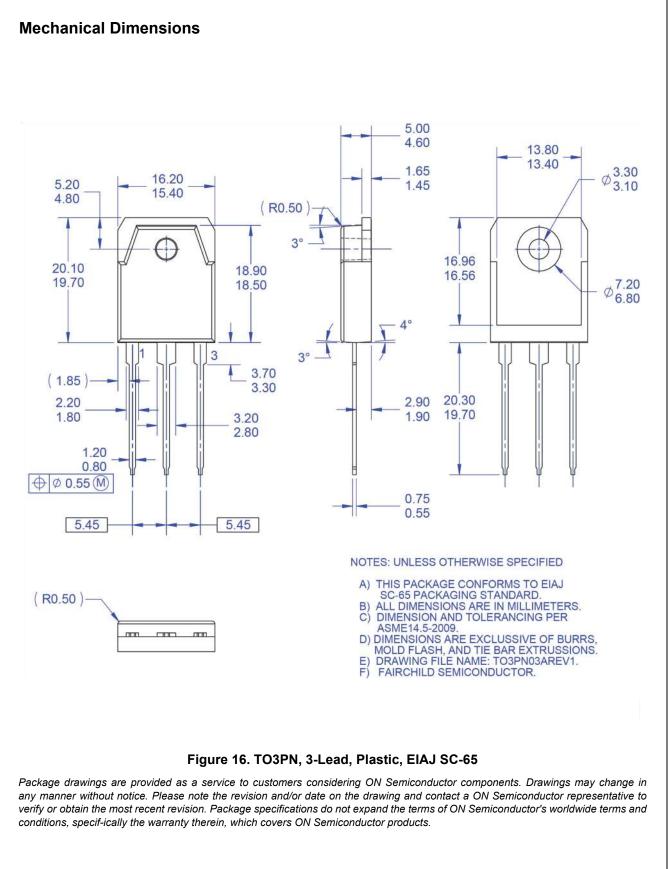


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